

#### ABSTRACT

This user's guide describes the TPS23730 evaluation module (EVM). The TPS23730 evaluation module (TPS23730EVM-093) contains evaluation and reference circuitry for the TPS23730, which is a IEEE802.3bt Type 3 PoE PD, EA Gen 2 Ready, controller suitable for Type 3 (51 W) PoE PD applications. The TPS23730EVM-093 is targeted for a 12-V active clamp forward high efficiency 50-W solution.

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### **1** Introduction

The TPS23730EVM-093 allows reference circuitry evaluation of the TPS23730 device and contains input and output power connectors and an array of onboard test points for circuit evaluation.

#### 1.1 Features

- IEEE802.3bt Type 3 compliant PoE PD
- Integrated PWM Controller for Active Clamp Forward Configuration
- Frequency Dithering for EMI Reduction
- Soft-Start Control with Advanced Startup and Hiccup Mode Overload Protection
- Soft-Stop Shutdown

### **1.2 Applications**

- IEEE 802.3bt Compliant Devices
- Video and VoIP Telephones
- Access Points
- Pass-through System
- Security Cameras
- Redundant Power Feeds or Power Sharing

#### 2 Electrical Specifications

#### Table 2-1. TPS23730EVM-093 Electrical and Performance Specifications at 25°C

Design Example Specifications									
Parameter	Test Conditions	MIN	ТҮР	MAX	Unit				
Power Interface	· · · · ·		1						
Input Voltage Range	Applied to the PoE Input	37	48	57					
	Applied ot the Adapter Input		48		V				
Detection Voltage	At device terminals	2.7		10.1	v				
Classification Voltage	At device terminals	14.5		20.5					
Classification			6						
Inrush current-limit			140		mA				
Operating Current Limit			1.85		А				
DC-to-DC Converter	· · · · ·								
Output Voltage	Vin = 48 V, iload <=iload (max)		12		V				
Output Current	37 V <= Vin <= 57 V		5		А				
Output Ripple Voltage peak-to- peak	Vin = 48 V, iload = 1 A	82			mV				
	Vin = 48 V, iload = 500 mA	71							
Efficiency, End to End	Vin = 48 V, iload = 2.5 A		89.9		%				
	Vin = 48 V, iload = 5 A		91						
Switching Frequency			250		kHz				



## **3 Description**

The TPS23730VM-093 enables full evaluation of the TPS23730 device. Refer to the schematic shown in Figure 4-1 and Figure 4-2. Ethernet power is applied from J2 and is dropped to the bridge rectifier (Q1-Q4, D1-D4 and other passives). The Power over Ethernet (PoE) transformer needed to transfer power or data is T1. The Bob Smith Terminations help balance the Ethernet cabled impedance and are critical for ESD and EMI or EMC performance. The EMI or EMC filter and transient protection for the TPS23730 device are at the output of the bridge rectifier.

Input power can also be applied at J3 from a DC source when power at J1 is not present.

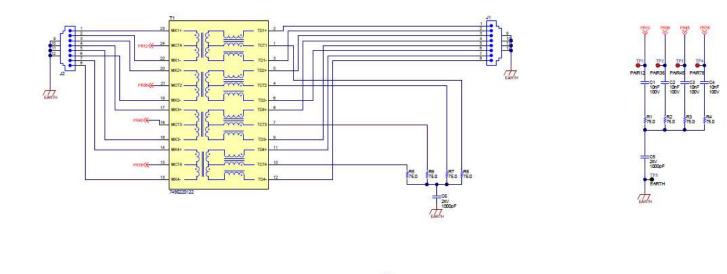
The TPS23703 (U1) PD and DC-to-DC converter circuitry is shown in Figure 1. R36 provides the detection signature. The switched side of the PD controller is to the right of U1. The TPS23730 RTN pins provides inrush limited turn on and charge of the bulk capacitor, C19.

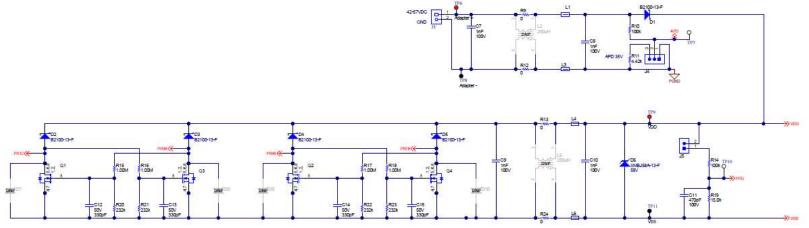
The DC-to-DC converter is a high-efficiency active clamp forward converter.

R43 provides a means for error injection to measure the frequency response of the converter.



### 4 Schematic and Bill of Materials







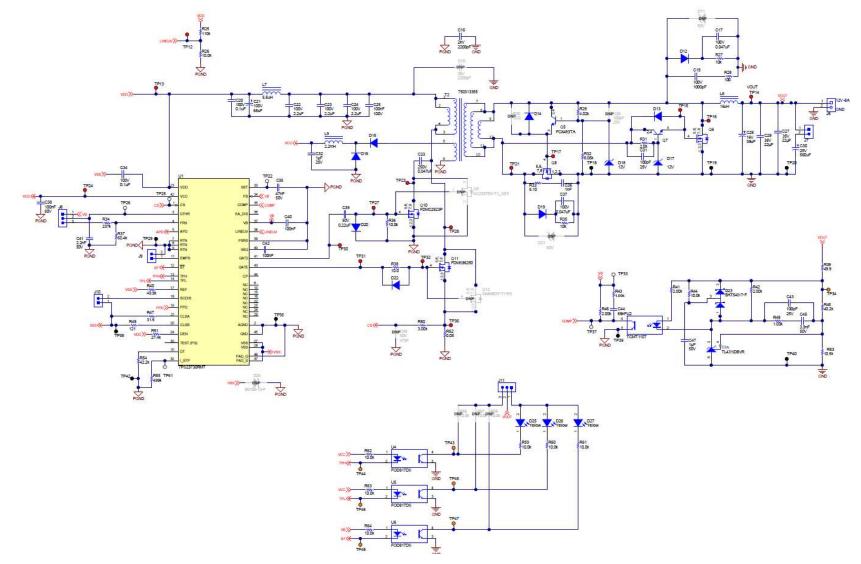


Figure 4-2. TPS23730EVM-093 Schematic Page Two



# 5 General Configuration and Description

## 5.1 Physical Access

Table 5-1 lists the EVM connector functionality. Table 5-2 describes the test point availability and jumper functionality.

Description								
connects DTH to either FRS or VB								
Enable or disable APD for adapter input from J3								
connects PPD divider, which allows a lower turn on voltage								
Enable or disable EMPS								
Select TPL serial or parallel								
Select TPH, TPL, BT to output on resistor, LED, or leave open								
Connects extra output capacitance C15								

#### Table 5-1. Connector Functionality

#### Table 5-2. Test Points

Test Point	Description
TP1	Pair 12
TP2	Pair 36
TP3	Pair 45
TP4	Pair 78
TP5	Earth
TP6	Adapter Positive Input
TP7	PPD
TP8	Adapter Negative Input
TP9	VDD
TP10	APD
TP11	VSS
TP12	LINEUV
TP13	VDD
TP14	VOUT
TP15	Gate of Q6
TP16	Drain of Q6
TP17	Gate of Q8
TP18	GND
TP19	GND
TP20	GND
TP21	Drain of Q8
TP22	SST
TP23	Drain of Q10
TP24	VCC
TP25	CS
TP26	DTHR
TP27	Gate of Q10
TP28	Drain of Q11
TP29	RTN

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Table 5-2. Test Points (continued)							
Test Point	Description						
TP30	GAT2						
TP31	GATE						
TP32	Gate of Q11						
TP33	VB						
TP34	Loop						
TP35	PGND						
TP36	Source of Q11 - Sense Resistor						
TP37	COMP						
TP38	VSS						
TP39	PGND						
TP40	GND						
TP41	I_STP						
TP42	PGND						
TP43	TPH Opto Output						
TP44	ТРН						
TP45	TPL Opto Output						
TP46	TPL						
TP47	BT Opto Output						
TP48	BT						

#### Table 5-2. Test Points (continued)

# 6 TPS23730EVM-093 Performance Data

### 6.1 Startup to PSE and DCDC Startup

Figure 6-1 shows the startup response of the TPS23730EVM-093. Figure 6-1

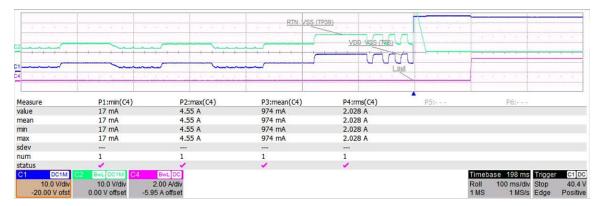


Figure 6-1. Startup Response When Connected to a PoE PSE

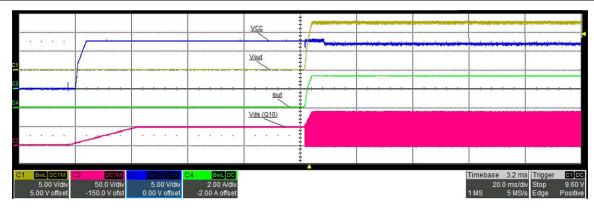


Figure 6-2. DC/DC Startup

### 6.2 Soft-Stop Response

The TPS23730 has a soft stop feature that enables a controlled discharge of the output bulk capacitance. Please refer to SLVAEY9 for more information. Figure 6-3 and Figure 6-4 show the 5-V output waveform after the input voltage is removed.

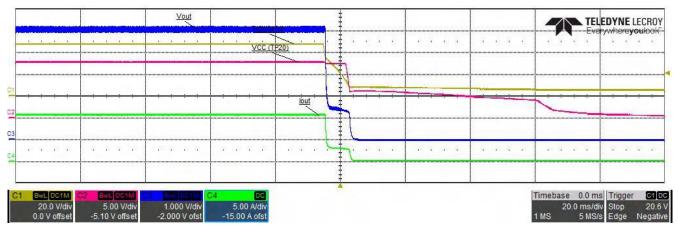


Figure 6-3. Shutdown Waveform 10-A Load

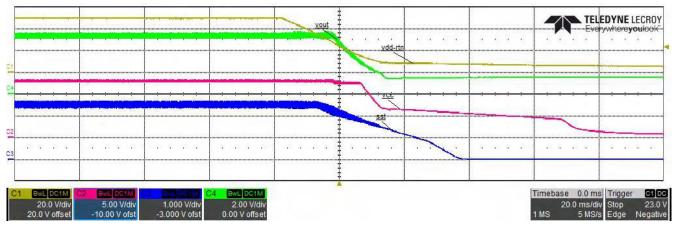
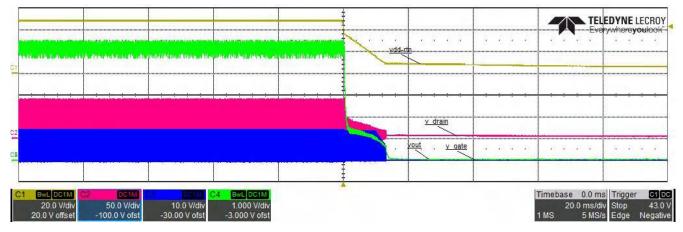




Figure 6-5 shows the primary MOSFET Q11 during shutdown.







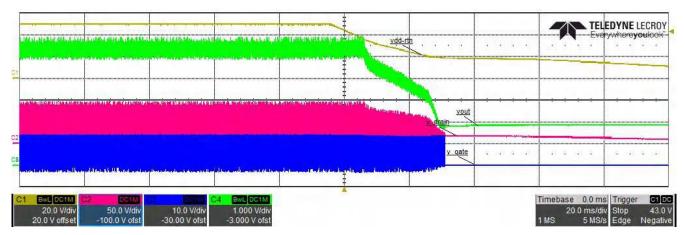


Figure 6-6. Shutdown Waveform Primary MOSFET with 0-A Load

Figure 6-7 and Figure 6-8 show the primary sync MOSFET Q10 during shutdown.

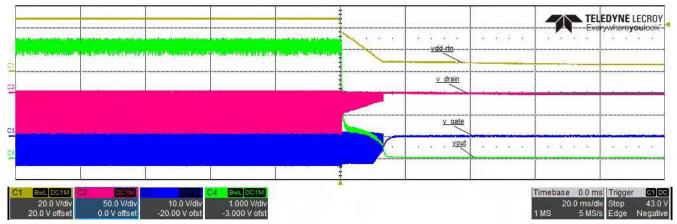


Figure 6-7. Shutdown Waveform Synchronous MOSFET with 10-A Load



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Figure 6-9 and Figure 6-10 show the secondary series MOSFET Q8 during shutdown.

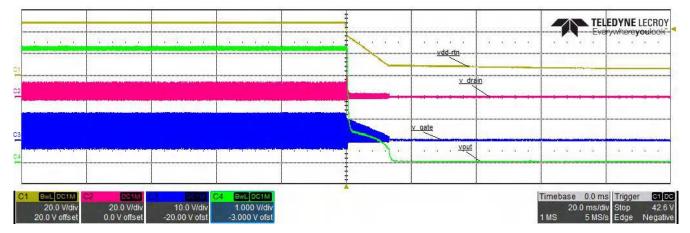
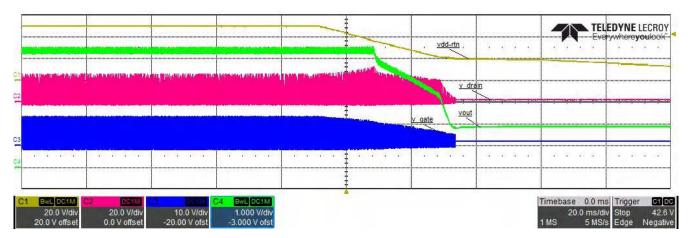


Figure 6-9. Shutdown Waveform Secondary Series MOSFET 10-A Load



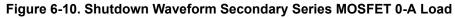
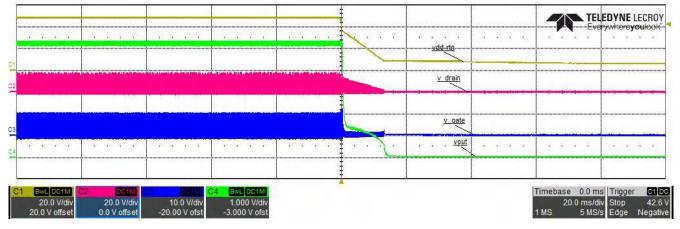


Figure 6-11 and Figure 6-12 show the secondary parallel MOSFET Q6 during shutdown.







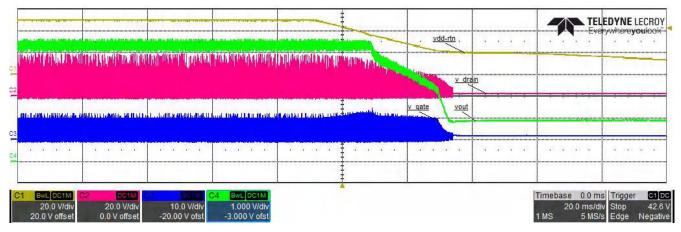
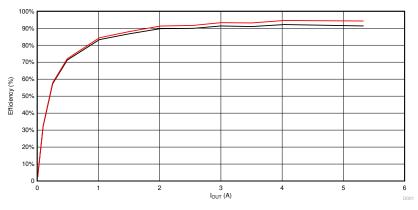
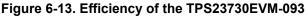


Figure 6-12. Shutdown Waveform Secondary Parallel MOSFET 0-A Load

### 6.3 Efficiency

Figure 6-13 shows the efficiency of the TPS23730EVM-093







### 6.4 Load Regulation

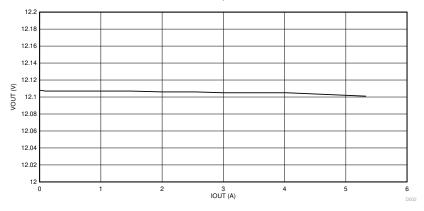


Figure 6-14. TPS23730EVM-093 Load Regulation

### 6.5 Hiccup Performance During an Output Short

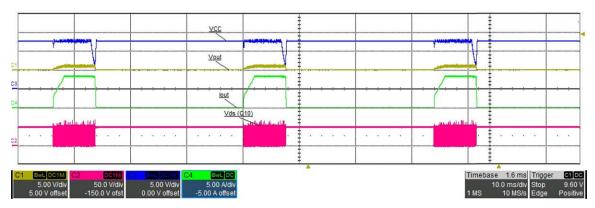
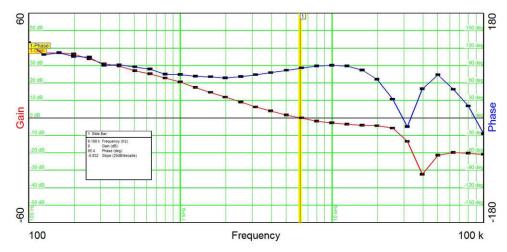


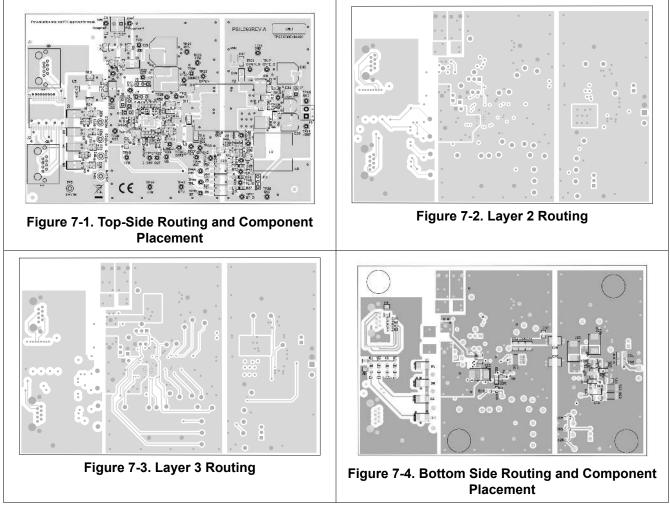
Figure 6-15. DCDC Hiccup Performance during an Output Short



### 6.6 Bode Plot

Figure 6-16. Bode Plot Response of the TPS23730EVM-093 with 5-A Load

## 7 EVM Assembly Drawings and Layout Guidelines 7.1 PCB Drawings



### 7.2 Layout Guidelines

The layout of the PoE front end must follow power and EMI or ESD best-practice guidelines. A basic set of recommendations includes:

- TI recommends having at least 8 vias (PAD G) and 5 vias on (PAD S) connecting the exposed thermal pad through a top layer plane (2 oz copper recommended) to a bottom VSS plane (2 oz. copper recommended) to help with thermal dissipation.
- The primary MOSFET (Q10 in TPS23730EVM093) must be near the power transformer and the current sense resistor must be close to source of the MOSFET to minimize the primary loop. The same is true for the secondary MOSFETs. Keep the MOSFETs close to the transformer, and associated components as close together as possible to minimize the loop.
- Parts placement must be driven by power flow in a point-to-point manner; RJ-45, Ethernet transformer, diode bridges, TVS and 0.1-μF capacitor, and TPS23730 converter input bulk capacitor.
- Make all leads as short as possible with wide power traces and paired signal and return.
- · No crossovers of signals from one part of the flow to another are allowed.
- Spacing consistent with safety standards like IEC60950 must be observed between the 48-V input voltage rails and between the input and an isolated converter output.
- Use large copper fills and traces on SMT power-dissipating devices, and use wide traces or overlay copper fills in the power path.



Place the Schotty diode between VSS and RTN as close to the IC as possible, preferably on directly on the
opposite side of the board (ex. The TPS23730EVM-093 places the IC on the top side, so the diode is on the
bottom side directly underneath it).

The DC-to-DC converter layout benefits from basic rules such as:

- Having at least 4 vias (VDD) near the power transformer pin connected to VDD through multiple layer planes to help with thermal dissipation of the power transformer.
- Having at least 6 vias (secondary ground) near the power transformer pin connected to secondary ground through multiple layer planes to help with thermal dissipation of the power transformer.
- Pair signals to reduce emissions and noise, especially the paths that carry high-current pulses, which include the power semiconductors and magnetics
- Minimize the trace length of high current power semiconductors and magnetic components
- · Use the ground plane for the switching currents carefully
- Keep the high-current and high-voltage switching away from low-level sensing circuits including those outside the power supply
- · Proper spacing around the high-voltage sections of the converter

#### 7.3 EMI Containment

- Use compact loops for dv/dt and di/dt circuit paths (power loops and gate drives)
- Use minimal, yet thermally adequate, copper areas for heat sinking of components tied to switching nodes (minimize exposed radiating surface). Hide copper associated with switching nodes under shielded magnetics, where possible
- Use copper ground planes (possible stitching) and top-layer copper floods (surround circuitry with ground floods)
- Use a 4-layer PCB, if economically feasible (for better grounding)
- · Minimize the amount of copper area associated with input traces (to minimize radiated pickup)
- Heat sink the quiet side of components instead of the switching side, where possible (like the output side of inductor)
- Use Bob Smith terminations, Bob Smith EFT capacitor, and Bob Smith plane. Use Bob Smith plane as a ground shield on input side of PCB (creating a phantom or literal earth ground)
- Use LC filter at DC-to-DC input
- Dampen high-frequency ringing on all switching nodes, if present (allow for possible snubbers)
- · Control rise times with gate-drive resistors and possibly snubbers
- Switching frequency considerations
- Use of EMI bridge capacitor across isolation boundary (isolated topologies)
- Observe the polarity dot on inductors (embed noisy end)
- Use of ferrite beads on input (allow for possible use of beads or 0-Ω resistors)
- Maintain physical separation between input-related circuitry and power circuitry (use ferrite beads as boundary line)
- Balance efficiency versus acceptable noise margin
- Possible use of common-mode inductors
- Possible use of integrated RJ-45 jacks (shielded with internal transformer and Bob Smith terminations)
- End-product enclosure considerations (shielding)

### 8 Bill of Materials

The table below lists the TPS2730EVM-093 Bill of Materials (BOM).

Designator	Quantity	Value	Description	Package Reference	Part Number	Manufacturer	Alternate PartNumber	Alternate Manufacturer
PCB1	1		Printed Circuit Board		PSIL093	Any		
C1, C2, C3, C4	4	0.01uF	CAP, CERM, 0.01 uF, 100 V, +/- 10%, X7R, AEC- Q200 Grade 1, 0603	0603	CGA3E2X7R2A103K080AA	ТDК		
C5, C6	2	1000 pF	CAP, CERM, 1000 pF, 2000 V, +/- 10%, X7R, 1808	1808	GR442QR73D102KW01L	MuRata		
C7, C8, C9, C10	4	1000 pF	CAP, CERM, 1000 pF, 100 V, +/- 10%, X7R, 0603	0603	C1608X7R2A102K080AA	ТDК		
C11	1	470 pF	CAP, CERM, 470 pF, 100 V, +/- 10%, X7R, 0805	0805	08051C471KAT2A	AVX		
C12, C13, C14, C15	4	330 pF	CAP, CERM, 330 pF, 50 V, +/- 5%, C0G/NP0, 0603	0603	885012006060	Wurth Elektronik		
C16	1	2200 pF	CAP, CERM, 2200 pF, 2000 V, +/- 10%, X7R, 1812	1812	C4532X7R3D222K130KA	ТDК		
C17, C37	2	0.047uF	CAP, CERM, 0.047 uF, 100 V, +/- 10%, X7R, AEC-Q200 Grade 1, 1206	1206	CGA5H2X7R2A473K115AA	TDK		
C19	1	1000 pF	CAP, CERM, 1000 pF, 100 V, +/- 10%, X7R, 1206	1206	12061C102KAT2A	AVX		
C20, C34	2	0.1uF	CAP, CERM, 0.1 uF, 100 V, +/- 10%, X7R, 1206	1206	GRM319R72A104KA01D	MuRata		



Designator	Quantity	Value	Description	Package Reference	Part Number	Manufacturer	Alternate PartNumber	Alternate Manufacturer
C21	1	68uF	CAP, AL, 68 uF, 100 V, +/- 20%, 0.32 ohm, AEC- Q200 Grade 2, SMD	SMT Radial H13	EEV-FK2A680Q	Panasonic		
C22, C23, C24	3	2.2uF	CAP, CERM, 2.2 uF, 100 V, +/- 10%, X7R, 1210	1210	GRM32ER72A225KA35L	MuRata		
C25	1	0.1uF	CAP, CERM, 0.1 uF, 100 V, +/- 10%, X7R, 0805	0805	GRM21BR72A104KAC4L	MuRata		
C27, C29	2	22uF	CAP, CERM, 22 μF, 35 V,+/- 20%, X5R, 1210	1210	GMK325BJ226MM-P	Taiyo Yuden		
C28	1	39uF	CAP, Aluminum Polymer, 39 uF, 16 V, +/- 20%, 0.05 ohm, 6.3x5.8 SMD	6.3x5.8	16SVP39M	Panasonic		
C30	1	560uF	CAP, AL, 560 uF, 25 V, +/- 20%, 0.08 ohm, AEC- Q200 Grade 2, SMD	D10xL10.2mm	EEEFPE561UAP	Panasonic		
C31, C43	2	100 pF	CAP, CERM, 100 pF, 25 V, +/- 10%, X7R, 0603	0603	06033C101KAT2A	AVX		
C32	1	1uF	CAP, CERM, 1 uF, 25 V, +/- 10%, X7R, 0805	0805	GRM21BR71E105KA99L	MuRata		
C33	1	0.047uF	CAP, CERM, 0.047 uF, 250 V, +/- 10%, X7R, 1206	1206	GRM31CR72E473KW03L	MuRata		
C35	1	0.047uF	CAP, CERM, 0.047 uF, 50 V, +/- 10%, X7R, 0603	0603	GRM188R71H473KA61D	MuRata		

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Designator (1)	Quantity	Value	Description	Package Reference	Part Number	Manufacturer	Alternate PartNumber	Alternate Manufacturer
C36	1	1000 pF	CAP, CERM, 1000 pF, 100 V, +/- 10%, X7R, AEC- Q200 Grade 1, 0603	0603	CGA3E2X7R2A102K080AA	TDK		
C38	1	0.1uF	CAP, CERM, 0.1 uF, 50 V, +/- 10%, X7R, AEC-Q200 Grade 1, 0805	0805	GCM21BR71H104KA37K	MuRata		
C39	1	0.22uF	CAP, CERM, 0.22 uF, 50 V, +/- 10%, X5R, 0805	0805	C2012X5R1H224K125AA	ТDК		
C40	1	0.1uF	CAP, CERM, 0.1 uF, 25 V, +/- 10%, X7R, AEC-Q200 Grade 1, 0603	0603	CGA3E2X7R1E104K080AA	TDK		
C41	1	2200 pF	CAP, CERM, 2200 pF, 50 V, +/- 10%, X7R, 0603	0603	C0603C222K5RAC	Kemet		
C42	1	0.1uF	CAP, CERM, 0.1 uF, 25 V, +/- 5%, X7R, 0603	0603	C0603C104J3RACTU	Kemet		
C44	1	0.068uF	CAP, CERM, 0.068 uF, 16 V, +/- 10%, X7R, 0603	0603	GRM188R71C683KA01D	MuRata		
C45	1	3900 pF	CAP, CERM, 3900 pF, 50 V, +/- 10%, X7R, 0603	0603	GRM188R71H392KA01D	MuRata		
C47	1	1uF	CAP, CERM, 1 uF, 50 V, +/- 10%, X7R, 0805	0805	C2012X7R1H105K125AB	ТDК		
D1, D2, D3, D4, D5	5	100 V	Diode, Schottky, 100 V, 2 A, SMB	SMB	B2100-13-F	Diodes Inc.		
D6	1	58 V	Diode, TVS, Uni, 58 V, 93.6 Vc, SMB	SMB	SMBJ58A-13-F	Diodes Inc.		



Designator	Quantity	Value	Description	Package Reference	Part Number	Manufacturer	Alternate PartNumber	Alternate Manufacturer
D12, D19	2	100 V	Diode, Ultrafast, 100 V, 2 A, SMA	SMA	MURA110T3G	ON Semiconductor		
D13, D14, D15, D16, D20, D22	6	100 V	Diode, Switching, 100 V, 0.2 A, SOD-123	SOD-123	MMSD914T1G	ON Semiconductor		
D17, D18	2	12 V	Diode, Zener, 12 V, 500 mW, SOD-123	SOD-123	MMSZ5242B-7-F	Diodes Inc.		
D23	1	30 V	Diode, Schottky, 30 V, 0.2 A, SOT-23	SOT-23	BAT54S-7-F	Diodes Inc.		
D25, D26, D27	3	Yellow	LED, Yellow, SMD	LED_0603	150060YS75000	Wurth Elektronik		
FID1, FID2, FID3	3		Fiducial mark. There is nothing to buy or mount.	N/A	N/A	N/A		
H1, H2, H3, H4	4		Bumpon, Hemisphere, 0.44 X 0.20, Clear	Transparent Bumpon	SJ-5303 (CLEAR)	3M		
J1, J2	2		RJ45, No LED, tab up, R/A, TH	16.26x14.54x15.75	1-406541-1	TE Connectivity		
J3	1		Terminal Block, 3.5 mm, 2x1, Tin, TH	Terminal Block, 3.5 mm, 2x1, TH	39357-0002	Molex		
J4, J8, J11	3		Header, 100mil, 3x1, Tin, TH	Header, 3x1, 100mil, TH	5-146278-3	TE Connectivity		
J5	1		Header, 100mil, 2x1, Tin, TH	Header, 2 PIN, 100mil, Tin	PEC02SAAN	Sullins Connector Solutions		
J6	1		Terminal Block, 3.5mm Pitch, 2x1, TH	7.0x8.2x6.5mm	ED555/2DS	On-Shore Technology		
J7, J9, J10	3		Header, 100mil, 2x1, Tin, TH	Header, 2x1, 100mil, TH	5-146278-2	TE Connectivity		



Designator	Quantity	Value	Description	Package Reference	Part Number	Manufacturer	Alternate PartNumber	Alternate Manufacturer
L1, L3, L4, L6	4	300 ohm	Ferrite Bead, 300 ohm @ 100 MHz, 2 A, 0603	0603	742792641	Wurth Elektronik		
L7	1	5.5uH	Inductor, Shielded Drum Core, Superflux, 5.5 uH, 10 A, 0.0112 ohm, SMD	WE-HC6	744325550	Wurth Elektronik		
L8	1	15uH	Inductor, Shielded Drum Core, Ferrite, 15 uH, 14 A, 0.009 ohm, SMD	18.3x8.9x18.2mm	74435571500	Wurth Elektronik		
L9	1	2.2mH	Inductor, Unshielded Drum Core, Metal Composite, 2.2 mH, 0.15 A, 6 ohm, SMD	7x5x7.8mm	768775322	Wurth Elektronik		
LBL1	1		Thermal Transfer Printable Labels, 0.650" W x 0.200" H - 10,000 per roll	PCB Label 0.650 x 0.200 inch	THT-14-423-10	Brady		
Q1, Q2, Q3, Q4	4	100 V	MOSFET, N-CH, 100 V, 4.5 A, DQK0006C (WSON-6)	DQK0006C	CSD19538Q2	Texas Instruments		None
Q5, Q7	2	100 V	Transistor, NPN, 100 V, 1 A, SOT-89	SOT-89	FCX493TA	Diodes Inc.		
Q6, Q8	2	80 V	MOSFET, N-CH, 80 V, 100 A, PG- TDSON-8	PG-TDSON-8	BSC057N08NS3 G	Infineon Technologies		None
Q10	1	-150V	MOSFET, P-CH, -150 V, -3 A, QFN-8	QFN-8	FDMC2523P	Fairchild Semiconductor		None



Designator	Quantity	Value	Description	Package Reference	Part Number	Manufacturer	Alternate PartNumber	Alternate Manufacturer
Q11	1	150 V	MOSFET, N-CH, 150 V, 6.7 A, PQFN08A	PQFN08A	FDMS86250	Fairchild Semiconductor		None
R1	1	75.0	RES, 75.0, 1%, 0.1 W, AEC-Q200 Grade 0, 0603	0603	CRCW060375R0FKEA	Vishay-Dale		
R2, R3, R4, R5, R6, R7, R8	7	75.0	RES, 75.0, 1%, 0.1 W, 0603	0603	CRCW060375R0FKEA	Vishay-Dale		
R9, R12, R13, R24	4	0	RES, 0, 0%, W, AEC-Q200 Grade 0, 0805	0805	PMR10EZPJ000	Rohm		
R10, R14	2	100k	RES, 100 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603	0603	CRCW0603100KFKEA	Vishay-Dale		
R11	1	4.42k	RES, 4.42 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603	0603	CRCW06034K42FKEA	Vishay-Dale		
R15, R16, R17, R18	4	1.00Meg	RES, 1.00 M, 1%, 0.1 W, AEC-Q200 Grade 0, 0603	0603	CRCW06031M00FKEA	Vishay-Dale		
R19	1	15.0k	RES, 15.0 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603	0603	CRCW060315K0FKEA	Vishay-Dale		
R20, R21, R22, R23	4	232k	RES, 232 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603	0603	CRCW0603232KFKEA	Vishay-Dale		
R25	1	110k	RES, 110 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603	0603	CRCW0603110KFKEA	Vishay-Dale		
R26, R36, R44, R59, R60, R61, R62, R63, R64	9	10.0k	RES, 10.0 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603	0603	CRCW060310K0FKEA	Vishay-Dale		

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Designator	Quantity	Value	Description	Package Reference	Part Number	Manufacturer	Alternate PartNumber	Alternate Manufacturer
R27, R35	2	10k	RES, 10 k, 5%, 1 W, AEC-Q200 Grade 0, 2512	2512	CRCW251210K0JNEG	Vishay-Dale		
R28	1	100	RES, 100, 5%, 1 W, AEC-Q200 Grade 0, 2512	2512	CRCW2512100RJNEG	Vishay-Dale		
R29	1	4.02k	RES, 4.02 k, 1%, 0.25 W, AEC- Q200 Grade 0, 1206	1206	CRCW12064K02FKEA	Vishay-Dale		
R31	1	2.0k	RES, 2.0 k, 5%, 0.1 W, AEC-Q200 Grade 0, 0603	0603	CRCW06032K00JNEA	Vishay-Dale		
R32	1	8.06k	RES, 8.06 k, 1%, 0.25 W, AEC- Q200 Grade 0, 1206	1206	CRCW12068K06FKEA	Vishay-Dale		
R33	1	5.10	RES, 5.10, 1%, 0.125 W, AEC- Q200 Grade 0, 0805	0805	ERJ-6RQF5R1V	Panasonic		
R34	1	237k	RES, 237 k, 1%, 0.1 W, 0603	0603	RC0603FR-07237KL	Yageo		
R37	1	60.4k	RES, 60.4 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603	0603	CRCW060360K4FKEA	Vishay-Dale		
R38	1	10.0	RES, 10.0, 1%, 0.1 W, 0603	0603	CRCW060310R0FKEA	Vishay-Dale		
R39	1	49.9	RES, 49.9, 1%, 0.1 W, 0603	0603	RC0603FR-0749R9L	Yageo		
R40	1	49.9k	RES, 49.9 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603	0603	CRCW060349K9FKEA	Vishay-Dale		



Designator	Quantity	Value	Description	Package Reference	Part Number	Manufacturer	Alternate PartNumber	Alternate Manufacturer
R41, R46	2	2.00k	RES, 2.00 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603	0603	CRCW06032K00FKEA	Vishay-Dale		
R42	1	2.00k	RES, 2.00 k, 1%, 0.1 W, 0603	0603	Y16362K00000F9R	Vishay Foil Resistors		
R43	1	1.00k	RES, 1.00 k, 1%, 0.1 W, 0603	0603	RC0603FR-071KL	Yageo		
R45	1	40.2k	RES, 40.2 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603	0603	CRCW060340K2FKEA	Vishay-Dale		
R47	1	31.6	RES, 31.6, 1%, 0.125 W, AEC- Q200 Grade 0, 0805	0805	CRCW080531R6FKEA	Vishay-Dale		
R48	1	1.00k	RES, 1.00 k, 1%, 0.1 W, 0603	0603	CRCW06031K00FKEA	Vishay-Dale		
R49	1	121	RES, 121, 1%, 0.125 W, AEC- Q200 Grade 0, 0805	0805	CRCW0805121RFKEA	Vishay-Dale		
R50	1	3.00k	RES, 3.00 k, 1%, 0.1 W, 0603	0603	RC0603FR-073KL	Yageo		
R51	1	27.4k	RES, 27.4 k, 1%, 0.1 W, 0603	0603	RC0603FR-0727K4L	Yageo		
R52	1	0.05	RES, 0.05, 1%, 1 W, AEC-Q200 Grade 0, 1206	1206	ERJ-8CWFR050V	Panasonic		
R53	1	10.5k	RES, 10.5 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603	0603	CRCW060310K5FKEA	Vishay-Dale		
R54	1	42.2k	RES, 42.2 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603	0603	CRCW060342K2FKEA	Vishay-Dale		



Designator	Quantity	Value	Description	Package Reference	Part Number	Manufacturer	Alternate PartNumber	Alternate Manufacturer
R55	1	499k	RES, 499 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603	0603	CRCW0603499KFKEA	Vishay-Dale		
SH-J1, SH- J2, SH-J3, SH-J4, SH- J5, SH-J6, SH-J7	7		Shunt, 2.54mm, Gold, Black	Shunt, 2.54mm, Black	60900213421	Wurth Elektronik		
T1	1	350uH	Transformer, 350 uH, SMT	14.7x18.29mm	7490220122	Wurth Elektronik		
T2	1		Power Over Ethernet (PoE) For Configurable (For DC/DC) SMPS Transformer 1500Vrms Isolation Surface Mount	SMT_XFRMR_29MM08_23MM1	750313355	Wurth Elektronik	LDT8627-50R	Linkcom
TP1, TP2, TP3, TP4	4		Test Point, Multipurpose, Red, TH	Red Multipurpose Testpoint	5010	Keystone		
TP5	1		Test Point, Multipurpose, Black, TH	Black Multipurpose Testpoint	5011	Keystone		
TP6, TP9, TP12, TP13, TP14, TP15, TP16, TP17, TP21, TP23, TP24, TP27, TP28, TP30, TP31, TP32, TP36	17		Test Point, Miniature, Red, TH	Red Miniature Testpoint	5000	Keystone		
TP7, TP10, TP22, TP25, TP26, TP33, TP37, TP41	8		Test Point, Miniature, White, TH	White Miniature Testpoint	5002	Keystone		



Designator	Quantity	Value	Description	Package Reference	Part Number	Manufacturer	Alternate PartNumber	Alternate Manufacturer
TP8, TP11, TP18, TP19, TP20, TP29, TP35, TP38, TP39, TP40, TP42	11		Test Point, Miniature, Black, TH	Black Miniature Testpoint	5001	Keystone		
TP34, TP43, TP44, TP45, TP46, TP47, TP48	7		Test Point, Miniature, Orange, TH	Orange Miniature Testpoint	5003	Keystone		
U1	1		TPS23730RMT, RMT0045A (VQFN-45)	RMT0045A	TPS23730RMT	Texas Instruments		Texas Instruments
U2	1		Optocoupler, 3.75 kV, 80-160% CTR, SMT	SOP-4	TCMT1107	Vishay- Semiconductor		
U3	1		Adjustable Precision Shunt Regulator, 34 ppm / degC, 100 mA, -40 to 85 degC, 5-pin SOT-23 (DBV), Green (RoHS & no Sb/Br)	DBV0005A	TL431IDBVR	Texas Instruments		
U4, U5, U6	3		Optocoupler, 5 kV, 300-600% CTR, SMT	DIP-4L Gullwing	FOD817DS	Fairchild Semiconductor		
C18	0	2200 pF	CAP, CERM, 2200 pF, 2000 V, +/- 10%, X7R, 1812	1812	C4532X7R3D222K130KA	TDK		
C26	0	100 pF	CAP, CERM, 100 pF, 25 V, +/- 10%, X7R, 0603	0603	06033C101KAT2A	AVX		

Bill of Materials



Designator	Quantity	Value	Description	Package Reference	Part Number	Manufacturer	Alternate PartNumber	Alternate Manufacturer
C46	0	47 pF	CAP, CERM, 47 pF, 50 V, +/- 5%, C0G/NP0, 0603	0603	GRM1885C1H470JA01D	MuRata		
D7, D8, D9, D10	0	100 V	Diode, Schottky, 100 V, 2 A, SMB	SMB	B2100-13-F	Diodes Inc.		
D11, D21	0	60 V	Diode, TVS, Uni, 60 V, SMC	SMC	SMCJ60A	Fairchild Semiconductor		
D24	0	100 V	Diode, Schottky, 100 V, 3 A, SMC	SMC	B3100-13-F	Diodes Inc.		
L2, L5	0	250uH	Coupled inductor, 250 uH, A, 0.035 ohm, SMD	8.7x10mm	744272251	Wurth Elektronik		
Q9	0	-80V	MOSFET, P-CH, -80 V, -2.2 A, AEC-Q101, SOT-23	SOT-23	SQ2337ES-T1_GE3	Vishay-Siliconix		None
Q12	0	150 V	MOSFET, N-CH, 150 V, 2.7 A, SOIC-8	SOIC-8	SI4848DY-T1-E3	Vishay-Siliconix		None
R30	0	10.0	RES, 10.0, 1%, 0.25 W, AEC- Q200 Grade 0, 0603	0603	CRCW060310R0FKEAHP	Vishay-Dale		
R56, R57, R58	0	10.0k	RES, 10.0 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603	0603	CRCW060310K0FKEA	Vishay-Dale		

(1) Unless otherwise noted in the Alternate Part Number and Alternate Manufacturer columns, all parts can be substituted with equivalents.



### **9 Revision History**

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

CI	nanges from Revision A (December 2020) to Revision B (August 2023)	Page
•	Changed PCB drawings	14
•	Added alternate part number to Bill of Materials	16
CI	nanges from Revision * (May 2020) to Revision A (December 2020)	Page
<u>CI</u>	nanges from Revision * (May 2020) to Revision A (December 2020) Updated the numbering format for tables, figures and cross-references throughout the document	
•	Updated the numbering format for tables, figures and cross-references throughout the document	1
•		

#### STANDARD TERMS FOR EVALUATION MODULES

- 1. Delivery: TI delivers TI evaluation boards, kits, or modules, including any accompanying demonstration software, components, and/or documentation which may be provided together or separately (collectively, an "EVM" or "EVMs") to the User ("User") in accordance with the terms set forth herein. User's acceptance of the EVM is expressly subject to the following terms.
  - 1.1 EVMs are intended solely for product or software developers for use in a research and development setting to facilitate feasibility evaluation, experimentation, or scientific analysis of TI semiconductors products. EVMs have no direct function and are not finished products. EVMs shall not be directly or indirectly assembled as a part or subassembly in any finished product. For clarification, any software or software tools provided with the EVM ("Software") shall not be subject to the terms and conditions set forth herein but rather shall be subject to the applicable terms that accompany such Software
  - 1.2 EVMs are not intended for consumer or household use. EVMs may not be sold, sublicensed, leased, rented, loaned, assigned, or otherwise distributed for commercial purposes by Users, in whole or in part, or used in any finished product or production system.
- 2 Limited Warranty and Related Remedies/Disclaimers:
  - 2.1 These terms do not apply to Software. The warranty, if any, for Software is covered in the applicable Software License Agreement.
  - 2.2 TI warrants that the TI EVM will conform to TI's published specifications for ninety (90) days after the date TI delivers such EVM to User. Notwithstanding the foregoing, TI shall not be liable for a nonconforming EVM if (a) the nonconformity was caused by neglect, misuse or mistreatment by an entity other than TI, including improper installation or testing, or for any EVMs that have been altered or modified in any way by an entity other than TI, (b) the nonconformity resulted from User's design, specifications or instructions for such EVMs or improper system design, or (c) User has not paid on time. Testing and other quality control techniques are used to the extent TI deems necessary. TI does not test all parameters of each EVM. User's claims against TI under this Section 2 are void if User fails to notify TI of any apparent defects in the EVMs within ten (10) business days after delivery, or of any hidden defects with ten (10) business days after the defect has been detected.
  - 2.3 TI's sole liability shall be at its option to repair or replace EVMs that fail to conform to the warranty set forth above, or credit User's account for such EVM. TI's liability under this warranty shall be limited to EVMs that are returned during the warranty period to the address designated by TI and that are determined by TI not to conform to such warranty. If TI elects to repair or replace such EVM, TI shall have a reasonable time to repair such EVM or provide replacements. Repaired EVMs shall be warranted for the remainder of the original warranty period. Replaced EVMs shall be warranted for a new full ninety (90) day warranty period.

## <u>WARNING</u>

Evaluation Kits are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems.

User shall operate the Evaluation Kit within TI's recommended guidelines and any applicable legal or environmental requirements as well as reasonable and customary safeguards. Failure to set up and/or operate the Evaluation Kit within TI's recommended guidelines may result in personal injury or death or property damage. Proper set up entails following TI's instructions for electrical ratings of interface circuits such as input, output and electrical loads.

NOTE:

EXPOSURE TO ELECTROSTATIC DISCHARGE (ESD) MAY CAUSE DEGREDATION OR FAILURE OF THE EVALUATION KIT; TI RECOMMENDS STORAGE OF THE EVALUATION KIT IN A PROTECTIVE ESD BAG.

3 Regulatory Notices:

3.1 United States

3.1.1 Notice applicable to EVMs not FCC-Approved:

**FCC NOTICE:** This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

3.1.2 For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:

#### CAUTION

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

#### FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

#### FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.
- 3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210 or RSS-247

#### Concerning EVMs Including Radio Transmitters:

This device complies with Industry Canada license-exempt RSSs. Operation is subject to the following two conditions:

(1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

#### Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

#### **Concerning EVMs Including Detachable Antennas:**

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

#### Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur

- 3.3 Japan
  - 3.3.1 Notice for EVMs delivered in Japan: Please see http://www.tij.co.jp/lsds/ti\_ja/general/eStore/notice\_01.page 日本国内に 輸入される評価用キット、ボードについては、次のところをご覧ください。

https://www.ti.com/ja-jp/legal/notice-for-evaluation-kits-delivered-in-japan.html

3.3.2 Notice for Users of EVMs Considered "Radio Frequency Products" in Japan: EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required to follow the instructions set forth by Radio Law of Japan, which includes, but is not limited to, the instructions below with respect to EVMs (which for the avoidance of doubt are stated strictly for convenience and should be verified by User):

- 1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
- 2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
- 3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

【無線電波を送信する製品の開発キットをお使いになる際の注意事項】 開発キットの中には技術基準適合証明を受けて

いないものがあります。 技術適合証明を受けていないもののご使用に際しては、電波法遵守のため、以下のいずれかの 措置を取っていただく必要がありますのでご注意ください。

- 1. 電波法施行規則第6条第1項第1号に基づく平成18年3月28日総務省告示第173号で定められた電波暗室等の試験設備でご使用 いただく。
- 2. 実験局の免許を取得後ご使用いただく。
- 3. 技術基準適合証明を取得後ご使用いただく。
- なお、本製品は、上記の「ご使用にあたっての注意」を譲渡先、移転先に通知しない限り、譲渡、移転できないものとします。 上記を遵守頂けない場合は、電波法の罰則が適用される可能性があることをご留意ください。 日本テキサス・イ

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- 3.3.3 Notice for EVMs for Power Line Communication: Please see http://www.tij.co.jp/lsds/ti\_ja/general/eStore/notice\_02.page 電力線搬送波通信についての開発キットをお使いになる際の注意事項については、次のところをご覧くださ い。https://www.ti.com/ja-jp/legal/notice-for-evaluation-kits-for-power-line-communication.html
- 3.4 European Union
  - 3.4.1 For EVMs subject to EU Directive 2014/30/EU (Electromagnetic Compatibility Directive):

This is a class A product intended for use in environments other than domestic environments that are connected to a low-voltage power-supply network that supplies buildings used for domestic purposes. In a domestic environment this product may cause radio interference in which case the user may be required to take adequate measures.

#### 4 EVM Use Restrictions and Warnings:

- 4.1 EVMS ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.
- 4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.
- 4.3 Safety-Related Warnings and Restrictions:
  - 4.3.1 User shall operate the EVM within TI's recommended specifications and environmental considerations stated in the user guide, other available documentation provided by TI, and any other applicable requirements and employ reasonable and customary safeguards. Exceeding the specified performance ratings and specifications (including but not limited to input and output voltage, current, power, and environmental ranges) for the EVM may cause personal injury or death, or property damage. If there are questions concerning performance ratings and specifications, User should contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may also result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM user guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, even with the inputs and outputs kept within the specified allowable ranges, some circuit components may have elevated case temperatures. These components include but are not limited to linear regulators, switching transistors, pass transistors, current sense resistors, and heat sinks, which can be identified using the information in the associated documentation. When working with the EVM, please be aware that the EVM may become very warm.
  - 4.3.2 EVMs are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems. User assumes all responsibility and liability for proper and safe handling and use of the EVM by User or its employees, affiliates, contractors or designees. User assumes all responsibility and numeration between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard. User assumes all responsibility and liability for any improper or unsafe handling or use of the EVM by User or its employees, affiliates, contractors or designees.
- 4.4 User assumes all responsibility and liability to determine whether the EVM is subject to any applicable international, federal, state, or local laws and regulations related to User's handling and use of the EVM and, if applicable, User assumes all responsibility and liability for compliance in all respects with such laws and regulations. User assumes all responsibility and liability for proper disposal and recycling of the EVM consistent with all applicable international, federal, state, and local requirements.
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